

# PW2301

## 20V P-Channel MOSFET

-2.3A -20V;  $R_{DS(ON)typ}=80m\Omega @ -4.5V$ ,  $R_{DS(ON)typ}=110m\Omega @ -2.5V$

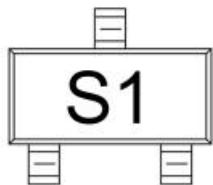
### FEATURE

- TrenchFET Power MOSFET
- Excellent  $R_{DS(on)}$  and Low Gate Charge

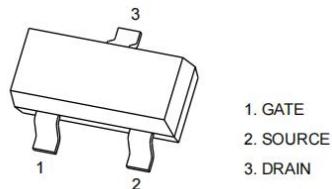
### Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

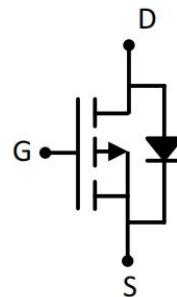
### MARKING:



SOT-23



Schematic diagram



### ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 10$	V
Continuous Drain Current	$I_D$	-2.3	A
Pulsed Drain Current( $t=300\mu s$ )	$I_{DM}$	-9.2	A
Power Dissipation	$P_D$	0.75	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	167	$^\circ C/W$
Junction Temperature	$T_J$	150	$^\circ C$
Storage Temperature	$T_{STG}$	-55~+150	$^\circ C$

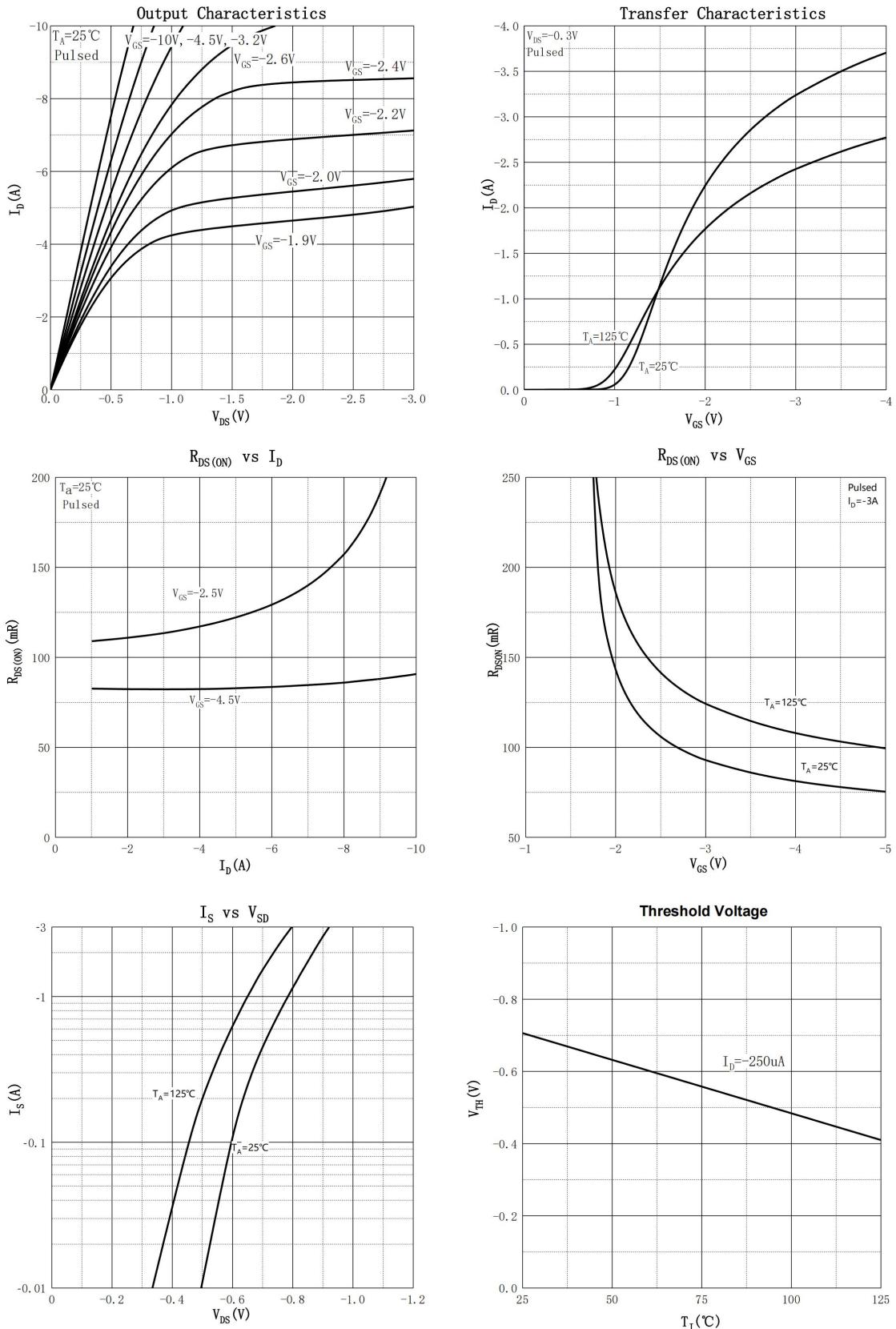
**MOSFET ELECTRICAL CHARACTERISTICS( $T_a=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Gate - Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 10\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS<sup>3</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250\mu\text{A}$	-0.4	-0.7	-1.0	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -3.0\text{A}$		80	112	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_{\text{D}} = -2.0\text{A}$		110	142	
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = -5\text{V}, I_{\text{D}} = -2.0\text{A}$	3			S
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		437		pF
Output Capacitance	$C_{\text{oss}}$			52		
Reverse Transfer Capacitance	$C_{\text{rss}}$			45		
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -3\text{A}$		4.87		nC
Gate-source Charge	$Q_{\text{gs}}$			0.99		
Gate-drain Charge	$Q_{\text{gd}}$			1.01		
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}$ $R_{\text{L}} = 10\Omega, R_{\text{G}} = 3\Omega$		12		ns
Turn-on Rise Time	$t_{\text{r}}$			36		
Turn-off Delay Time	$t_{\text{d}(\text{off})}$			32		
Turn-off Fall Time	$t_{\text{f}}$			9		
<b>SOURCE-DRAIN DIODE CHARACTERISTICS</b>						
Diode Forward Voltage <sup>3</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = -1.3\text{A}$			-1.2	V

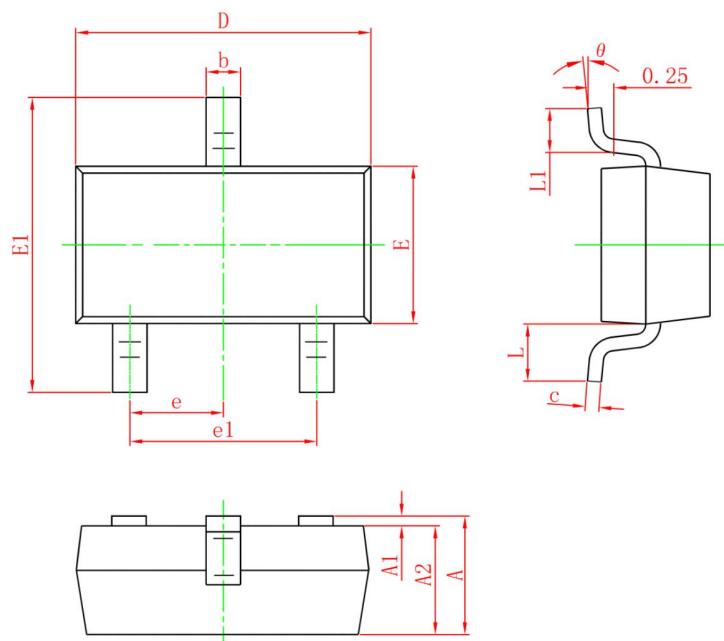
**Notes:**

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation PD is limited by  $T_j(\text{MAX}) = 150^\circ\text{C}$ .
- 5.Device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $TA = 25^\circ\text{C}$ .

## Typical Electrical and Thermal Characteristics



**SOT-23 Package Information**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0	0.100	0	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.150	1.500	0.045	0.059
E1	2.250	2.650	0.089	0.104
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°